## Effects of ammonia-ambient annealing on physical and electrical characteristics of rare earth CeO<sub>2</sub> as passivation film on silicon

## ABSTRACT

Effects of post-deposition annealing at 400–1000 °C in ammonia (NH<sub>3</sub>) gas ambient towards physical and electrical characteristics of metal-organic decomposition derived CeO<sub>2</sub> films spin-coated on n-type Si substrates were studied. The use of NH<sub>3</sub> annealing as N and H sources has promoted nitridation and passivation occurring at interface between the CeO<sub>2</sub> and Si. Mixed oxidation states (Ce<sup>4+</sup> and Ce<sup>3+</sup>) were detected in the samples via the detection of CeO<sub>2</sub> and Ce<sub>2</sub>O<sub>3</sub> phases, confirmed using high resolution X-ray diffraction analysis, Raman, and Fourier Transform Infrared studies. An increase in nitridation effect with respect to temperature has impeded the formation of Ce<sub>2</sub>Si<sub>2</sub>O<sub>7</sub> interfacial layer (IL) while the enhancement of passivation effect has triggered a decrease in interface trap density. Corresponding effects towards metal-oxide-semiconductor characteristics of the samples were discussed in details.

Keyword: Rare earth; CeO2; Ammonia annealing; Nitridation; Passivation